STRIP SOCKETS, SOLDER AND WIRE WRAP

- General Purpose High Reliability Strip Sockets.
- Tin/Gold Plating Option Available
- Side and End Stackable in -100 Version
- SBF Series designed to accept flexible jumper strips

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MATERIALS: (For applicable Mil Spec see Test Data section.)
BODY: Black polyester, glass-filled, or black nylon, glass-filled (see chart)
CONTACTS: Phosphor bronze, except WB is CA 725

CONTACT FINISH: Suffix TG, for SB-Products and WB-Products
Contact Area: 10 µ inch (.254 µ m) min. gold
over 50 µ inch (1.27 µ m) min. nickel

Terminal Area: 50 µ inch (1.27 µ m) min. electro tin
over 50 µ inch (1.27 µ m) min. nickel

Suffix G, 10 µ inch (.254 µ m) min. gold
over 50 µ inch (1.27 µ m) min. nickel
on contacts, gold flash on terminals

Suffix T, for SB-Products
30 µ inch (.762 µ m) min. hot tin dip and wipe

Suffix T, for WB Products
200 µ inch (5.08 µ m) min. tin

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SB-25-X A 2.500 (63.5) .175 (4.44) Polyester .015 (.381)
SB-25-100-X A 2.500 (63.5) .100 (2.54) Nylon .015 (.381)
SBF-25-100-X A 2.500 (63.5) .100 (2.54) Nylon .025 (.835)
WB-25-55-X B 2.500 (63.5) .175 (4.44) Polyester .015 (.381)

"X" denotes contact finish; Specify "TG" for tin/gold, "G" for gold, 
"T" for tin. 
(See Cu Contacts available — see pg. 22 "Burn-In Strip Sockets.

WB-9-55-T

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RATINGS:
TEMPERATURE RANGE: −65°C to +125°C
FLAMMABILITY: UL 94V-O

 Mounting Information:
For SB-Products
PCB HOLE: .035 ± .002" (0.89 ± .05)
LOCATION: Socket leads are offset .026" (.66)
from IC leads.

For WB-Products
PCB HOLE: .037 ± .002" (0.94 ± .05)
LOCATION: Socket leads are offset .018" (.46)
from IC leads.

OTHER MATERIALS: Anti-Wicking Wafer, Nomex 410
(not provided on WB products)

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